



1 CHANNEL UNIDIRECTIONAL TVS

Product Summary

V _{BR (Min)}	IPP (Max)	C _{T (Typ)}
6.5V	25A	200pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications, such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- · Computers and Peripheral

Features

- Low Profile Package (0.53mm Maximum) and Ultra-Small PCB Footprint Area (1.08mm x 0.68mm Maximum) Suitable for Compact Portable Electronics
- Provides ESD Protection per IEC 61000-4-2 Standard:
 - Air: ±30kV, Contact: ±30kV
- One Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (a4)
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Bottom View



Device Schematic

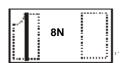
Ordering Information (Note 4)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity
D6V3E1U2LP-7B	Standard	8N	7	8	10,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, see https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



8N = Product Type Marking Code Bar Denotes Pin 1 or Cathode Side



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_{PP}	300	W	8/20µs, per Figure 3
Peak Pulse Current	I _{PP}	25	Α	8/20µs, per Figure 3
ESD Protection—Contact Discharge	V _{ESD_} CONTACT	±30	kV	IEC 61000-4-2 Standard
ESD Protection—Air Discharge	V _{ESD_AIR}	±30	kV	IEC 61000-4-2 Standard

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P_{D}	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\Theta JA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

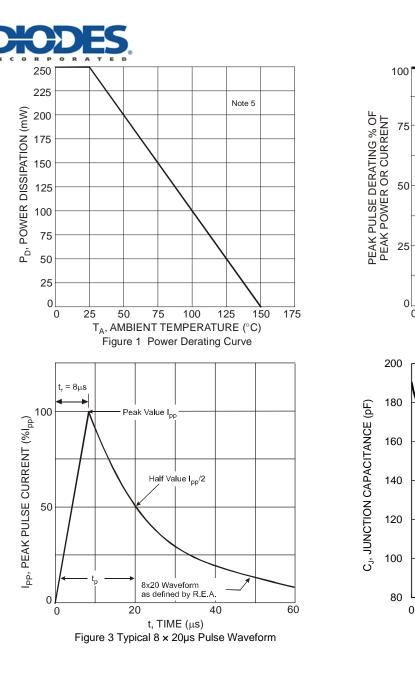
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

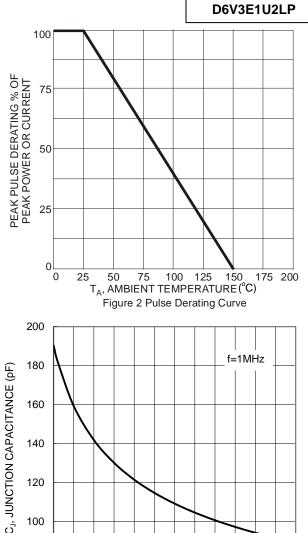
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Working Voltage	V_{RWM}	_	_	6.3	V	_
Reverse Current (Note 6)	I _R	_	0.1	1.0	μA	$V_R = V_{RWM} = 6.3V$
Reverse Breakdown Voltage	V_{BR}	6.5	_	9	V	I _R = 1mA
Deverse Clemning Voltage	V	_	9.0	11.0	V	$I_{PP} = 20A, t_p = 8/20\mu s$
Reverse Clamping Voltage	V _{CL}	_	10.5	12		$I_{PP} = 25A, t_p = 8/20\mu s$
Capacitance	Ст	_	200	_	pF	$V_R = 0V$, $f = 1MHz$

Notes:

^{5.} Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found at http://www.diodes.com/package-outlines.html.

^{6.} Short duration pulse test used to minimize self-heating effect.





V_R, REVERSE VOLTAGE (V) Figure 4 Typical Junction Capacitance

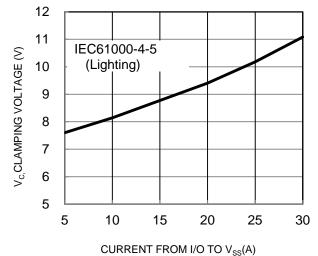
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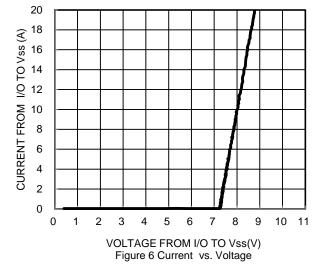
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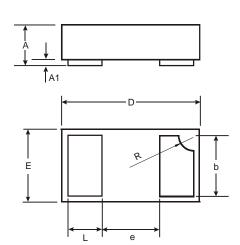






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



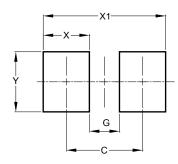
X1-DFN1006-2

X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A 1	0	0.05	0.03		
p	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	-		0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-2



Dimension	Value
s	(in mm)
С	0.70
G	0.30
Х	0.40
X1	1.10
Y	0.70



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